

• General Description

The AGM085N10F combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\text{DS(ON)}}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

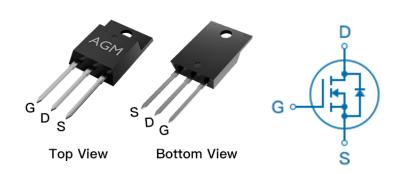
Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
100V	9mΩ	80A

TO-220F Pin Configuration



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM085N10F	AGM085N10F	TO-220F			1000

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	80	А
	Drain Current-Continuous(Tc=100℃)	52.5	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	320	А
PD	Maximum Power Dissipation(Tc=25℃)	78	W
	Maximum Power Dissipation(Tc=100℃)	31	w
EAS	Avalanche energy (Note 3)	210	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RøJA	Thermal Resistance Junction-ambient (Steady State) ¹		50	°C/W
RθJC	Thermal Resistance Junction-Case ¹		1.6	°C/W



Table 3. Electrical Characteristics (TJ=25°C unless otherwise noted)

Table 3. Electrical Characteristics (TJ=25℃ unless otherwise noted)							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
On/Off St	ates						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250µA	100			V	
IDSS	Zero Gate Voltage Drain Current	VDS=100V,VGS=0V			1	μΑ	
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA	
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250µA	1.2	1.6	2.2	V	
gFS	Forward Transconductance	VDS=5V,ID=15A		25		S	
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=20A		9.0	10.5	mΩ	
	,	VGS=4.5V, ID=15A		12.7	15	mΩ	
Dynamic	Characteristics						
Ciss	Input Capacitance	VDS=40V,VGS=0V,		2426		pF	
Coss	Output Capacitance	F=1MHZ		628		pF	
Crss	Reverse Transfer Capacitance			26		pF	
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		1.1		Ω	
Switching	g Times						
td(on)	Turn-on Delay Time			17		nS	
tr	Turn-on Rise Time	VGS=10V,VDS=50V,		4.0		nS	
td(off)	Turn-Off Delay Time	ID=20A,RGEN=3Ω		30		nS	
tf	Turn-Off Fall Time			8.0		nS	
Qg	Total Gate Charge			36.5		nC	
Qgs	Gate-Source Charge	VGS=10V, VDS=50V, ID=20A		7.0		nC	
Qgd	Gate-Drain Charge	- 15-207		9.0		nC	
Source-Drain Diode Characteristics							
ISD	Source-Drain Current(Body Diode)				80	Α	
VSD	Forward on Voltage	VGS=0V,IS=20A		0.9	1.2	V	
trr	Reverse Recovery Time	IF=20A , dl/dt=100A/μs ,		53.4		ns	
Qrr	Reverse Recovery Charge	TJ=25℃		62		nc	

Notes 1. The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}$ C,VDD=50V,Vgs=10V,ID=29A,L=0.5mH,RG=25ohm



Typical Performance Characteristics

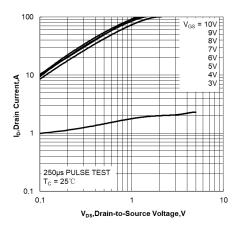


Figure 1. Output Characteristics

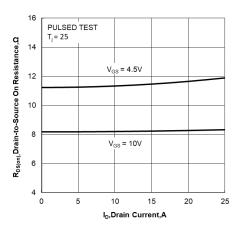


Figure 3. Drain-to-Source On Resistance vs Drain Current

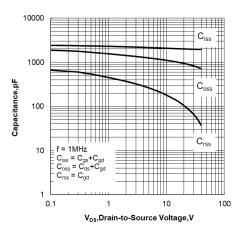


Figure 5. Capacitance Characteristics

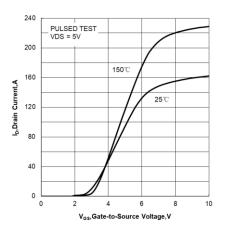


Figure 2. Transfer Characteristics

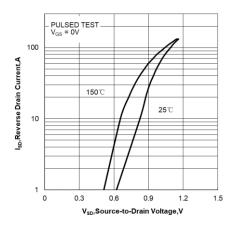


Figure 4. Body Diode Forward Voltage vs Source Current and Temperature

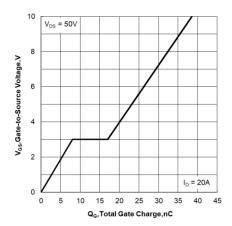


Figure 6. Gate Charge Characteristics



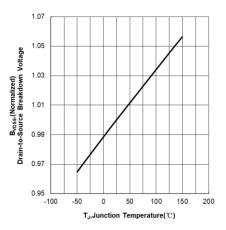


Figure 7. Normalized Breakdown Voltage vs Junction Temperature

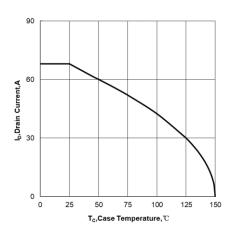


Figure 9. Maximum Continuous Drain Current vs Case Temperature

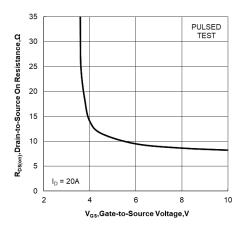


Figure11. Drain-to-Source On Resistance vs Gate
Voltage and Drain Current

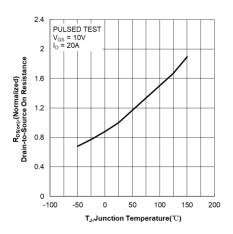


Figure 8. Normalized On Resistance vs

Junction Temperature

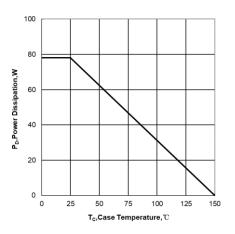


Figure 10. Maximum Power Dissipation vs Case Temperature

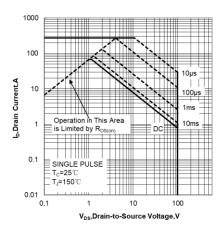


Figure 12. Maximum Safe Operating Area



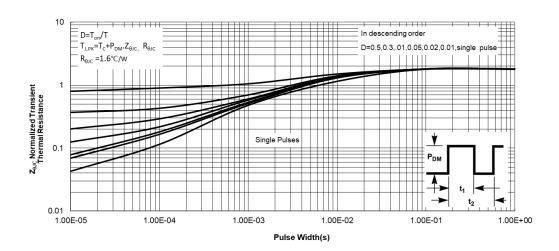
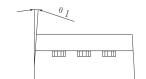
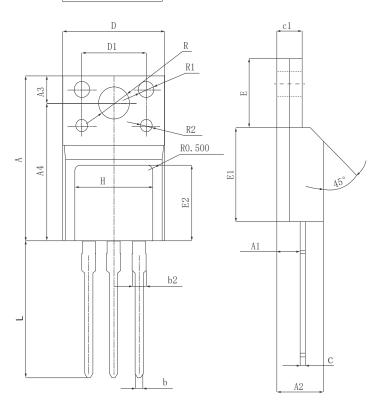


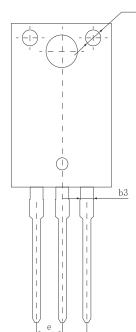
Figure 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case



•Dimensions (TO-220F)

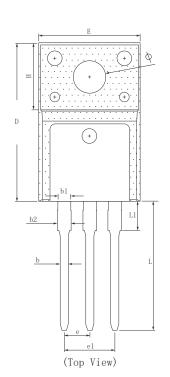


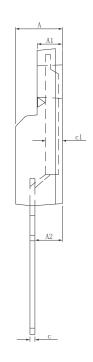


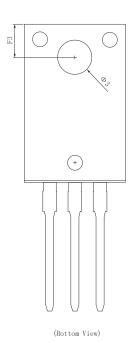


SYMBOL.	MILLIMETER			
SIMBUL	MIN	NOM	MAX	
A	15. 670	15. 870	16.070	
A1	2. 150	2, 350	2, 550	
A2	4.500	4. 700	4. 900	
A3	3, 100	3, 300	3, 500	
A4	12. 270	12.570	12. 870	
b	0.770	0.800	0.830	
b2	1.200	1.300	1.400	
ь3		1. 200BSC		
С	0.400	0.500	0.600	
c1	2. 440	2. 540	2. 640	
D	9.860	10.160	10.460	
D1	6.900	7.000	7.100	
Е	6. 480	6, 680	6. 880	
E1	8.990	9. 190	9, 390	
E2	7.100	7.300	7.500	
е	2. 540BSC			
e1		5. 080BSC		
L	13. 140	13.340	13. 540	
R	3, 100	3, 300	3, 500	
R1		1.500REF.		
R2	1. 200REF.			
R3	1.500REF.			
Н	7.600	7.800	8, 000	
θ 1	4°	4.5°	5°	

R3





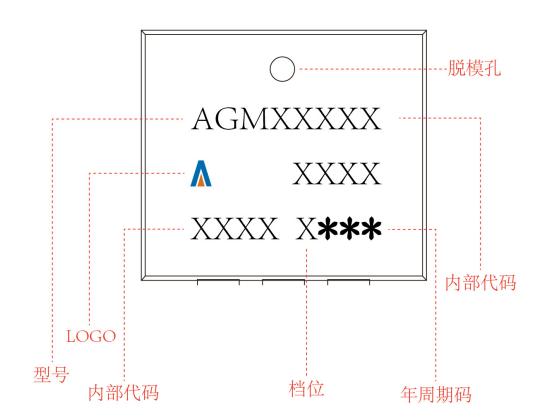


SYMBOL.	MILLIMETER			
STREOL	MIN	Typ.	MAX	
A	4. 500	4.700	4.900	
A1	2, 340	2.540	2.740	
A2	2, 560	2.760	2.960	
ь	0.700	0.800	0.950	
b1	1. 180	1.280	1.430	
b2	1. 250	1.350	1.550	
С	0.400	0.500	0.650	
c1	1. 200	1.300	1.350	
D	15, 570	15. 870	16. 170	
Н	6.700 REF			
Е	9, 960	10.160	10.360	
е	2. 540 BSC			
e1	5. 080 BSC			
L	12. 680 12. 980		13. 280	
L1	2. 780	2.930	3.080	
F3	3, 150	3, 300	3. 450	
Φ	3, 030	3.180	3. 450	
Ф3	3, 150	3.450	3, 650	

(注:全尺寸测量时c1不测)



TO-220F Marking Instructions:





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